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## FDC8602 Dual N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 1.2 A, 350 m $\Omega$

### Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 350 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 1.2 A
- Max r<sub>DS(on)</sub> = 575 mΩ at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 0.9 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

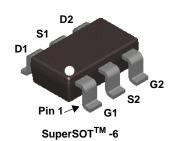


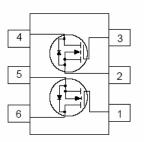
## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for  $r_{DS(on)}$ , switching performance and ruggedness.

## Applications

- Load Switch
- Synchronous Rectifier





### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

FDC8602

Symbol			Ratings	Units			
V <sub>DS</sub>	Drain to	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Note 1a)			1.2	A		
	-Pulsed			5	A		
E <sub>AS</sub>	Single P	Single Pulse Avalanche Energy (Note 3)			1.5	mJ	
P <sub>D</sub>	Power Dissipation			(Note 1a)	0.96	10/	
	Power D	issipation		(Note 1b)	0.69	W	
T <sub>J</sub> , T <sub>STG</sub>	Operatin	Operating and Storage Junction Temperature Range				°C	
Thermal Cl <sub>R<sub>θJC</sub></sub>		stics Resistance, Junction to C	Case		60		
$R_{\theta JA}$	Thermal	Resistance, Junction to A	130	°C/W			
Package M	arking a	nd Ordering Inform	ation				
Device Marking		Device	Package	Reel Size	Tape Width	Quantity	

.862

SSOT-6

7 "

8 mm

May 2013

3000 units

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N-Channel Shielded Gate PowerTrench <sup>®</sup> MOSFET
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V
∆BV <sub>DSS</sub>	Breakdown Voltage Temperature			70		
$\Delta T_J$	Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		73		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current $V_{GS} = \pm 20$ V, $V_{DS} = 0$ V				±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3.2	4	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			-8		mV/°0
$\Delta T_{J}$	Temperature Coefficient			-0		mv/-C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.2 A		285	350	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 0.9 A$		409	575	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 1.2 \text{ A}, T_J = 125 \text{ °C}$			600	_
9fs	Forward Transconductance	$V_{DS} = 10 V, I_{D} = 1.2 A$		1.3		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			53	70	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		17	25	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		0.8	5	pF
R <sub>g</sub>	Gate Resistance			1.6		Ω
*		I		1	1	
	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			3.5	10	ns
	Rise Time	$V_{DD}$ = 50 V, I <sub>D</sub> = 1.2 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		1.7	10	ns
t <sub>r</sub>	T 0" D   T	$V_{OO} \equiv 10$ V. KOEN $\equiv 0.0$		5.4	11	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	- GS - C - C - C - C - C - C - C - C - C -		0.0	40	
t <sub>d(off)</sub> t <sub>f</sub>	Fall Time			2.3	10	ns
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub>	Fall Time Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		1.2	2	nC
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>g(TOT)</sub>	Fall Time   Total Gate Charge   Total Gate Charge	$V_{GS} = 0 \ V \ to \ 10 \ V$ $V_{GS} = 0 \ V \ to \ 5 \ V$ $V_{DD} = 50 \ V,$		1.2 0.6		nC nC
$\begin{array}{c} t_{d(off)} \\ t_{f} \\ Q_{g(TOT)} \\ Q_{g(TOT)} \\ Q_{gs} \end{array}$	Fall Time     Total Gate Charge     Total Gate Charge     Gate to Source Charge	V <sub>GS</sub> = 0 V to 10 V		1.2 0.6 0.4	2	nC nC nC
t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>g(TOT)</sub>	Fall Time   Total Gate Charge   Total Gate Charge	$V_{GS} = 0 \ V \ to \ 10 \ V$ $V_{GS} = 0 \ V \ to \ 5 \ V$ $V_{DD} = 50 \ V,$		1.2 0.6	2	nC nC
$t_{d(off)}$ $t_{f}$ $Q_{g(TOT)}$ $Q_{gs}$ $Q_{gd}$	Fall Time     Total Gate Charge     Total Gate Charge     Gate to Source Charge	$V_{GS} = 0 \ V \ to \ 10 \ V$ $V_{GS} = 0 \ V \ to \ 5 \ V$ $V_{DD} = 50 \ V,$		1.2 0.6 0.4	2	nC nC nC
$t_{d(off)}$ $t_{f}$ $Q_{g(TOT)}$ $Q_{gs}$ $Q_{gd}$	Fall TimeTotal Gate ChargeTotal Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge	$V_{GS} = 0 \ V \ to \ 10 \ V$ $V_{GS} = 0 \ V \ to \ 5 \ V$ $V_{DD} = 50 \ V,$		1.2 0.6 0.4	2	nC nC nC
$\begin{array}{c} t_{d(off)} \\ t_{f} \\ Q_{g(TOT)} \\ Q_{g(TOT)} \\ Q_{gs} \\ Q_{gd} \end{array}$	Fall Time     Total Gate Charge     Total Gate Charge     Gate to Source Charge     Gate to Drain "Miller" Charge     urce Diode Characteristics	$V_{GS} = 0 \ V \ to \ 10 \ V$ $V_{GS} = 0 \ V \ to \ 5 \ V$ $V_{DD} = 50 \ V,$ $I_{D} = 1.2 \ A$		1.2 0.6 0.4 0.4	2	nC nC nC



2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

3. Starting  $T_J$  = 25 °C; N-ch: L = 3 mH,  $I_{AS}$  = 1 A,  $V_{DD}$  = 100 V,  $V_{GS}$  = 10 V.

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### Typical Characteristics $T_J = 25$ °C unless otherwise noted

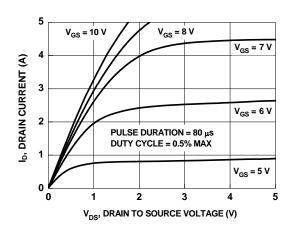


Figure 1. On Region Characteristics

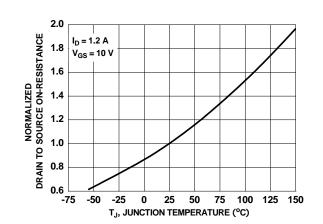
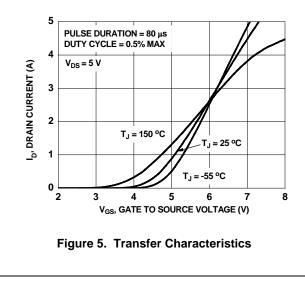


Figure 3. Normalized On Resistance vs Junction Temperature



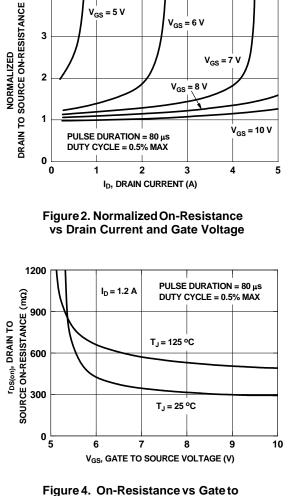
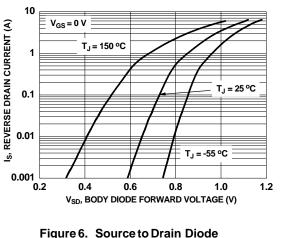
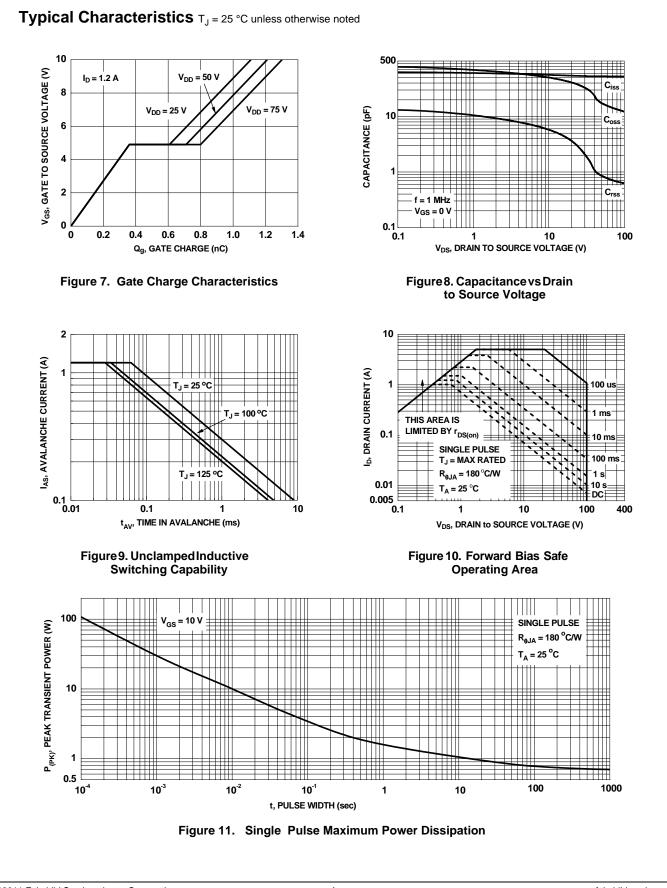


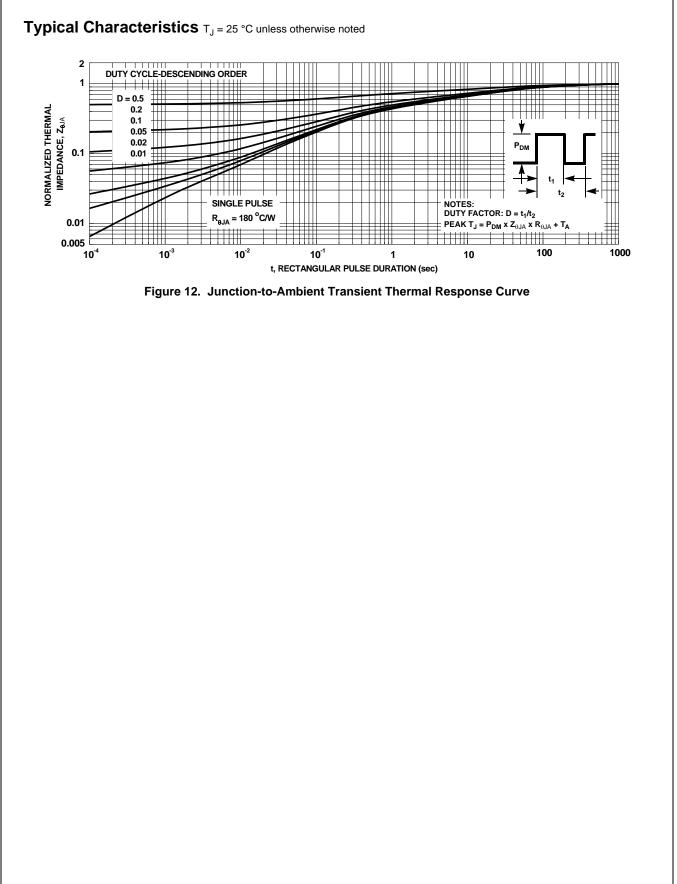
Figure 4. On-Resistance vs Gate to Source Voltage

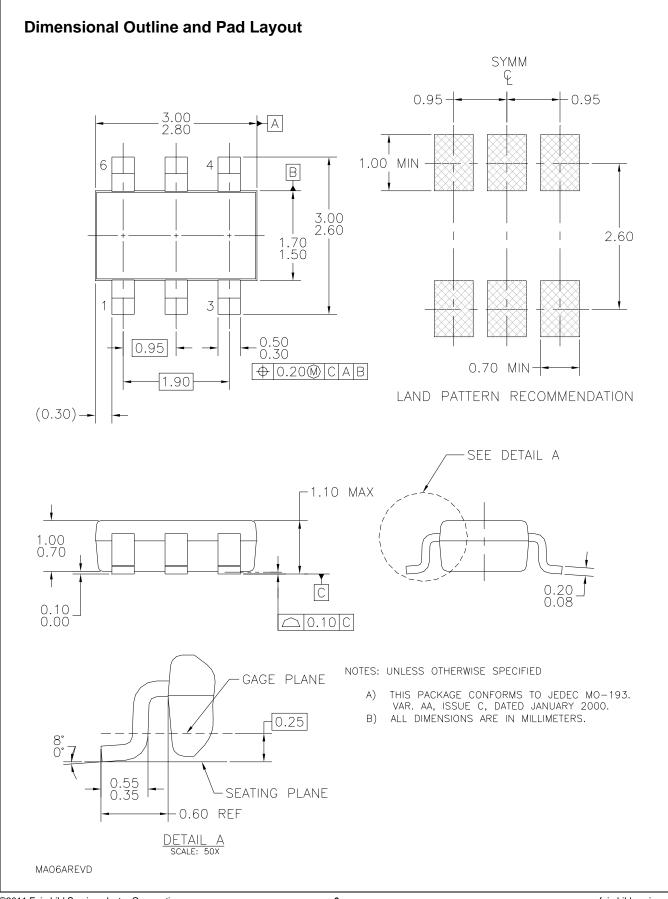


Forward Voltage vs Source Current



FDC8602 Dual N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET





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		Rev. I

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